



**UPM**  
UNIVERSITI PUTRA MALAYSIA  
BERILMU BERBAKTI



# SONY SCHOLARSHIP 2019

This year **Sony EMCS (Malaysia) Sdn. Bhd.** will continue the award of scholarship to potential UPM undergraduates.

The objective of our scholarship is to provide financial assistance to the students who are pursuing their education at a higher level in the fields of their choice and thus giving them the opportunity of employment upon graduation.

<b>ELIGIBILITIES</b>
<ul style="list-style-type: none"><li>▪ Malaysian citizen with age below 25.</li><li>▪ Pursuing Bachelor Degree IN ipta/ Public University.</li><li>▪ Outstanding academic achievements in school &amp; Pre-university</li><li>▪ Proficient in English, hardworking, excellent academic achievements with positive personality traits &amp; outstanding extra-curricular activities.</li><li>▪ Minimum CGPA 3.00</li><li>▪ RM 9,000.00 per annum</li></ul>
<b>AVAILABLE FOR</b>
<ul style="list-style-type: none"><li>➤ Bachelor of Engineering (Electrical &amp; Electronics, Mechanical or Mechatronics)</li><li>➤ Bachelor of Business (Economics, Marketing or Administration)</li><li>➤ Bachelor of IT or Computer Science (Software)</li><li>➤ Other fields related to the above disciplines.</li></ul>
<b>TERMS AND CONDITIONS</b>
Students will be bonded and must be willing to serve Sony EMCS (M) Sdn. Bhd. for a specified period of time upon completion of studies.
<b>HOW TO APPLY</b>
<ol style="list-style-type: none"><li>1. Application Form can be collected at Student Affairs Division, UPM <b>OR</b> <a href="mailto:KLScholarship.SOEM@ap.sony.com">KLScholarship.SOEM@ap.sony.com</a> to download the application form.</li><li>2. The completed application form with relevant documents should be sent to the address below: <b>Ms. Aliaa</b> <b>Human Resource Division</b> <b>Sony EMCS (Malaysia) Sdn. Bhd.</b> Lot 5, Jalan Kemajuan, Bangi Industrial Estate, 43650 Bandar Baru Bangi, Selangor Darul Ehsan. Phone No.: 03-8913 7211 Email: <a href="mailto:KLScholarship.SOEM@ap.sony.com">KLScholarship.SOEM@ap.sony.com</a></li></ol>
<b>DATELINE: 24 September 2019</b>

